

Product Change Notification / SYST-12WUIM914

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16-Nov-2021

Product Category:

8-bit Microcontrollers

PCN Type:

Document Change

Notification Subject:

ERRATA - ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification

Affected CPNs:

SYST-12WUIM914_Affected_CPN_11162021.pdf SYST-12WUIM914_Affected_CPN_11162021.csv

Notification Text:

SYST-12WUIM914

Microchip has released a new Product Documents for the ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification

Notification Status: Final

Description of Change: 1. Added data sheet clarifications:

Ordering InformationPackage Information

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 16 Nov 2021

NOTE: Please be advised that this is a change to the document only the product has not been changed. Markings to Distinguish Revised from Unrevised Devices: N/A
Attachments:
ATmega48A/PA/88A/PA/168A/PA/328/P Silicon Errata and Data Sheet Clarification
Please contact your local Microchip sales office with questions or concerns regarding this notification. Terms and Conditions:
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Affected Catalog Part Numbers (CPN)

ATMEGA48PA-15MZ

ATMEGA48PA-15MZV01

ATMEGA48PA-15AZ

ATMEGA48PA-15AZV03

ATMEGA88PA-15AZT

ATMEGA88A-PU

ATMEGA88PA-PU

ATMEGA88PA-MMH

ATMEGA88A-MMH

ATMEGA88A-MU

ATMEGA88PA-MU

ATMEGA88PA-AU

ATMEGA88A-AU

ATMEGA88PA-AUA6

ATMEGA88PA-PN

ATMEGA88PA-MMN

ATMEGA88PA-MN

ATMEGA88PA-AN

ATMEGA88PA-MMNR

ATMEGA88PA-MNR

ATMEGA88PA-ANR

ATMEGA88PA-MMUR

ATMEGA88PA-MMHR

ATMEGA88A-MMHR

ATMEGA88A-MUR

ATMEGA88PA-MUR

ATMEGA88PA-MURA6

ATMEGA88PA-AUR

ATMEGA88PA-AURA3

ATMEGA88A-AUR

ATMEGA88PA-15MZ

ATMEGA88PA-15MZV03

ATMEGA88PA-15MZV04

ATMEGA88PA-15MZV05

ATMEGA88PA-15MZV06

ATMEGA88PA-15MZV07

ATMEGA88PA-15AZ

ATMEGA88PA-15AZV01

ATMEGA88PA-15AZV02

ATMEGA168PA-15AZT

ATMEGA168PA-15AZTV02

ATMEGA168A-PU

ATMEGA168PA-PU

ATMEGA168PA-MMH

ATMEGA168A-MMH

ATMEGA168PA-MU

Date: Monday, November 15, 2021

ATMEGA168A-MU

ATMEGA168PA-MUA2

ATMEGA168PA-AU

ATMEGA168A-AU

ATMEGA168PA-PN

ATMEGA168PA-MN

ATMEGA168PA-AN

ATMEGA168PA-MNR

ATMEGA168PA-ANR

ATMEGA168PA-MMHR

ATMEGA168A-MMHR

ATMEGA168PA-MUR

ATMEGA168A-MUR

ATMEGA168PA-MURA2

ATMEGA168PA-AUR

ATMEGA168A-AUR

ATMEGA168PA-15MZ

ATMEGA168PA-15MZV01

ATMEGA168PA-15MZV03

ATMEGA168PA-15MZV04

ATMEGA168PA-15AZ

ATMEGA328P-PU

ATMEGA328-PU

ATMEGA328P-MMH

ATMEGA328-MMH

ATMEGA328P-MU

ATMEGA328-MU

ATMEGA328P-MUA2

ATMEGA328-AU

ATMEGA328P-AU

ATMEGA328P-PN

ATMEGA328P-MN

ATMEGA328P-AN ATMEGA328P-MNR

ATMEGA328P-ANR

ATMEGA328P-MMHR

ATMEGA328-MMHR

ATMEGA328P-MUR

ATMEGA328-MUR

ATMEGA328-AUR

ATMEGA328P-AUR

ATMEGA328P-AURA0

ATMEGA328P-15MZ

ATMEGA328P-15AZ

ATMEGA48A-PU

ATMEGA48PA-PU

ATMEGA48PA-MMH

ATMEGA48A-MMH

ATMEGA48A-MU

Date: Monday, November 15, 2021

$SYST-12WUIM914-ERRATA-ATmega 48A/PA/88A/PA/168A/PA/328/P\ Silicon\ Errata\ and\ Data\ Sheet\ Clarification$

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ATMEGA48A-AU

ATMEGA48PA-AU

ATMEGA48PA-PN

ATMEGA48PA-MMN

ATMEGA48PA-MN

ATMEGA48PA-AN

ATMEGA48PA-MMNR

ATMEGA48PA-MNR

ATMEGA48PA-ANR

ATMEGA48PA-MMHR

ATMEGA48A-MMHR

ATMEGA48A-MUR

ATMEGA48PA-MUR

ATMEGA48A-AUR

ATMEGA48PA-AUR

ATMEGA48PA-AURB0

Date: Monday, November 15, 2021



Silicon Errata and Data Sheet Clarifications

Introduction

The ATmega48A/PA/88A/PA/168A/PA/328/P devices you have received conform functionally to the current device data sheet (www.microchip.com/DS40002061), except for the anomalies described in this document. The erratas described in this document will likely be addressed in future revisions of the ATmega48A/PA/88A/PA/168A/PA/328/P devices.

Note:

• This document summarizes all the silicon errata issues from all revisions of silicon, previous as well as current.

Silicon Issue Summary 1.

Legend

- Erratum is not applicable.
- Χ Erratum is applicable.

			Valid for Silicon Revision							
Peripheral	Short Description	AT OF STATE	ATM 40404040	AT A CO.	Al megaooArA	VIII O	d de la company		ATmega328/P	
		Rev. D (1)	Rev. E	Rev. F (1)	Rev. G	Rev. E (1)	Rev. L	Rev. A	Rev. B	Rev. D
System Clock and Clock Options	2.2.1. Unstable 32 kHz Oscillator	-	-	-	-	-	-	Х	Х	-
TWI	2.3.1. TWI Data Setup Time Can Be Too Short	Х	Х	Х	Х	X	Х	-	-	Х
Analog Comparator	2.4.1. Analog MUX Can Be Turned Off When Setting the ACME Bit	Х	Х	Х	Х	Х	Х	Х	Х	Х

Note:

This revision is the initial release of the silicon.

The following silicon revisions were never released to production:

- ATmega168A/PA
 - Rev. F-K
- ATmega328/P
 - Rev. C

2. Silicon Errata Issues

2.1 **Errata Details**

- Erratum is not applicable.
- Χ Erratum is applicable.

System Clock and Clock Options 2.2

2.2.1 **Unstable 32 kHz Oscillator**

The 32 kHz oscillator does not work as a system clock and if it used as an asynchronous timer, it is inaccurate.

Work around

None.

Affected Silicon Revisions

ATmega48A/PA					
Rev. D			Rev. E		
-			-		
ATmega88A/PA					
Rev. F			Rev. G		
-			-		
	ATmega	168A/PA			
Rev. E	Rev. E		Rev. L		
-	-		-		
ATmega328/P					
Rev. A	Rev. B		Rev. D		
X	X		-		

2.3 TWI - Two-Wire Interface

2.3.1 TWI Data Setup Time Can Be Too Short

When running the device as a TWI slave with a system clock above 2 MHz, the data setup time for the first bit after ACK may, in some cases, be too short. This may cause a false start or stop condition on the TWI line.

Work around

Insert a delay between setting TWDR and TWCR.

Affected Silicon Revisions

ATmega48A/PA		
Rev. D	Rev. E	
Х	X	

ATmega88A/PA		
Rev. F	Rev. G	
X	X	

ATmega168A/PA		
Rev. E	Rev. L	
X	X	

ATmega328/P			
Rev. A	Rev. B	Rev. D	
-	-	X	

2.4 **AC - Analog Comparator**

2.4.1 Analog MUX Can Be Turned Off When Setting the ACME Bit

If the ACME (Analog Comparator Multiplexer Enabled) bit in ADCSRB is set while MUX3 in ADMUX is '1' (ADMUX[3:0]=1xxx), all MUXs are turned off until the ACME bit is cleared.

Work around

Clear the MUX3 bit before setting the ACME bit.

Affected Silicon Revisions

ATmega48A/PA		
Rev. D	Rev. E	
X	X	

ATmega88A/PA		
Rev. F	Rev. G	
X	X	

ATmega168A/PA		
Rev. E	Rev. L	
X	X	

ATmega328/P					
Rev. A Rev. B Rev. D					
X	X	Х			

Data Sheet Clarifications

3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (www.microchip.com/DS40002061).

Note: Corrections are shown in bold. Where possible, the original bold text formatting has been removed for clarity.

3.1 Ordering Information

A clarification has been made to tables titled 'Package Type' for all devices documented in the data sheet:

• A note to the 32M1-A row was added informing that the package type can be delivered in two different styles

Package Type				
32A	32-lead, (1.0 mm) Plastic Thin Quad Flat Package (TQFP)			
28M1	28-pad, 4 x 4 x 1.0 body, Lead Pitch 0.45 mm Very Thin Plastic Quad Flat No-Lead (VQFN)			
32M1-A ⁽¹⁾	32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50 mm Thin Plastic Quad Flat No-Lead (VQFN)			
28P3	28-lead, 0.300" Wide, Skinny Plastic Dual Inline Package (SPDIP)			

1. This package type can be delivered with two different styles with reference numbers 'C04-21400' (punched) and 'C04-21395' (sawn) as shown in section 3.2.1 - 32M1-A. For PCB layouts, it is recommended to take both recommended land patterns into consideration.

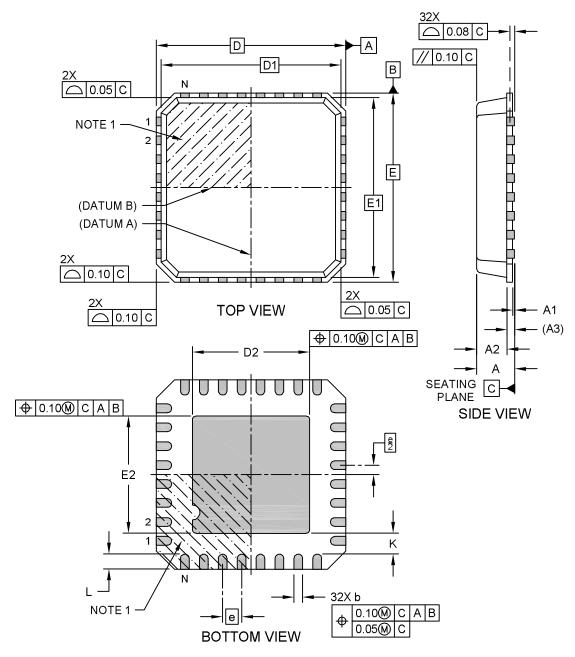
3.2 Package Information

A clarification about the other package style available for package type 32M1-A has been added to the 32M1-A section.

3.2.1 32M1-A

32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

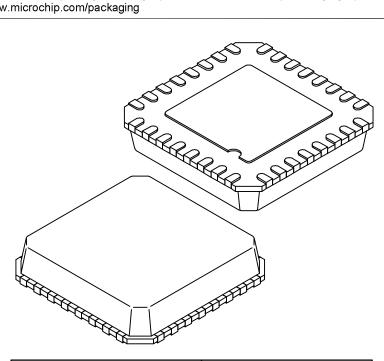
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-21400 Rev B Sheet 1 of 2

32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	32		
Pitch	е		0.50 BSC	
Overall Height	Α	0.80	0.85	1.00
Standoff	A1	0.00	0.02	0.05
Mold Cap Thickness	A2	ı	0.65	0.70
Terminal Thickness	А3	0.20 REF		
Overall Length	D	5.00 BSC		
Mold Cap Length	D1	4.75 BSC		
Exposed Pad Length	D2	2.95 3.10 3.25		
Overall Width	E	5.00 BSC		
Mold Cap Width	E1	4.75 BSC		
Exposed Pad Width	E2	2.95	3.10	3.25
Terminal Width	b	0.18	0.23	0.30
Terminal Length	Г	0.30	0.40	0.50
Terminal-to-Exposed-Pad	K	0.20		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is punch singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

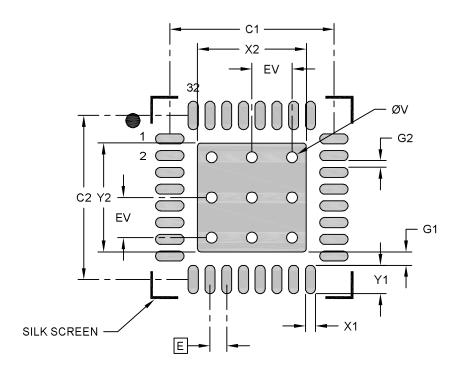
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21400 Rev B Sheet 2 of 2

32-Lead Thin Plastic Quad Flat, No Lead Package (S4B) - 5x5 mm Body [VQFN] Punch Singulated; 3.10x3.10 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	E	0.50 BSC		
Optional Center Pad Width	X2	3.25		
Optional Center Pad Length	Y2			3.25
Contact Pad Spacing	C1		4.90	
Contact Pad Spacing	C2		4.90	
Contact Pad Width (X32)	X1			0.30
Contact Pad Length (X32)	Y1			0.85
Contact Pad to Center Pad (X32)	G1	0.40		
Contact Pad to Contact Pad (X28)	G2	0.20		
Thermal Via Diameter			0.33	·
Thermal Via Pitch	EV		1.20	

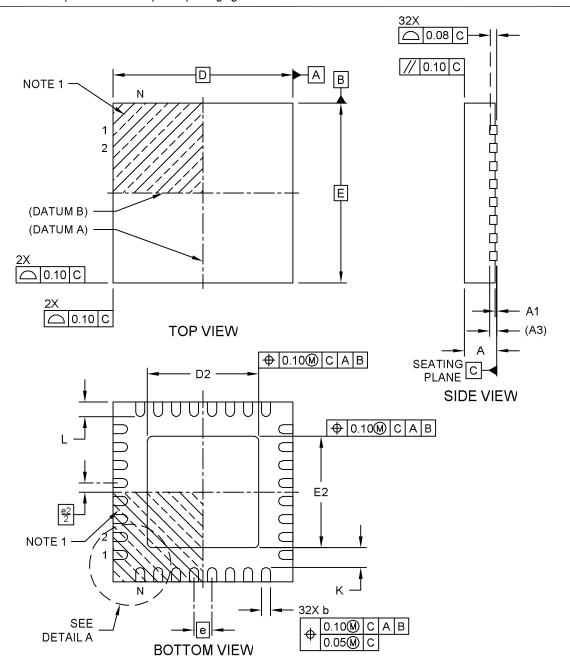
Notes:

- Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23400 Rev B

32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

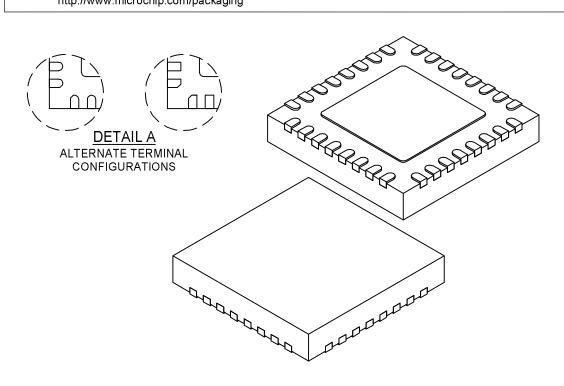
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-21395-UBB Rev C Sheet 1 of 2

32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	32		
Pitch	е	0.50 BSC		
Overall Height	Α	0.80	0.85	0.90
Standoff	A1	0.00 0.02 0.05		
Terminal Thickness	А3	0.203 REF		
Overall Length	D	5.00 BSC		
Exposed Pad Length	D2	3.00 3.10 3.20		
Overall Width	E	5.00 BSC		
Exposed Pad Width	E2	3.00	3.10	3.20
Terminal Width	b	0.18 0.25 0.30		
Terminal Length	L	0.30 0.40 0.50		
Terminal-to-Exposed-Pad	K	0.20		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

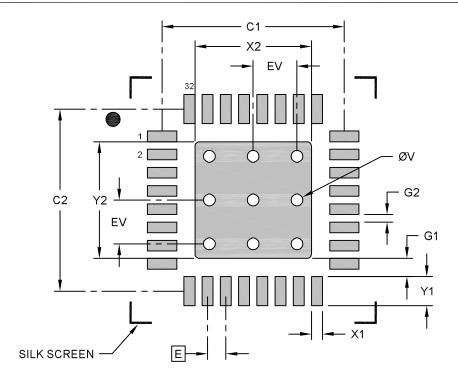
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-21395-UBB Rev C Sheet 2 of 2

32-Lead Very Thin Plastic Quad Flat, No Lead Package (UBB) - 5x5x0.9 mm Body [VQFN] With 3.1x3.1 mm Exposed Pad; Atmel Legacy Global Package Code ZMF

ote: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Contact Pitch	Е	0.50 BSC		
Center Pad Width	X2	3.20		
Center Pad Length	Y2			3.20
Contact Pad Spacing	C1		5.00	
Contact Pad Spacing	C2		5.00	
Contact Pad Width (X32)				0.30
Contact Pad Length (X32) Y				0.80
Contact Pad to Center Pad (X32)	G1	0.20		
Contact Pad to Contact Pad (X28)	G2	0.20		
Thermal Via Diameter V			0.33	
Thermal Via Pitch	EV		1.20	

Notes:

- Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23395-UBB Rev C

Document Revision History

4. **Document Revision History**

Note: The data sheet clarification document revision is independent of the die revision and the device variant (last letter of the ordering number).

Revision History 4.1

Doc Rev.	Date	Comments
В	11/2021	Added data sheet clarifications: Ordering Information Package Information
A	09/2020	Initial document release. Content moved from the data sheet and restructured to the new document template Updated the die revision list to reflect die revisions in production

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Boston	Tel: 852-2943-5100	Tel: 60-3-7651-7906	Germany - Heilbronn
Westborough, MA	China - Nanjing	Malaysia - Penang	Tel: 49-7131-72400
Tel: 774-760-0087	Tel: 86-25-8473-2460	Tel: 60-4-227-8870	Germany - Karlsruhe
Fax: 774-760-0088	China - Qingdao	Philippines - Manila	Tel: 49-721-625370
Chicago	Tel: 86-532-8502-7355	Tel: 63-2-634-9065	Germany - Munich
Itasca, IL	China - Shanghai	Singapore	Tel: 49-89-627-144-0
Tel: 630-285-0071	Tel: 86-21-3326-8000	Tel: 65-6334-8870	Fax: 49-89-627-144-44
Fax: 630-285-0075	China - Shenyang	Taiwan - Hsin Chu	Germany - Rosenheim
Dallas	Tel: 86-24-2334-2829	Tel: 886-3-577-8366	Tel: 49-8031-354-560
Addison, TX	China - Shenzhen	Taiwan - Kaohsiung	Israel - Ra'anana
Tel: 972-818-7423	Tel: 86-755-8864-2200	Tel: 886-7-213-7830	Tel: 972-9-744-7705
Fax: 972-818-2924	China - Suzhou	Taiwan - Taipei	Italy - Milan
Detroit	Tel: 86-186-6233-1526	Tel: 886-2-2508-8600	Tel: 39-0331-742611
Novi, MI	China - Wuhan	Thailand - Bangkok	Fax: 39-0331-466781
Tel: 248-848-4000	Tel: 86-27-5980-5300	Tel: 66-2-694-1351	Italy - Padova
Houston, TX	China - Xian	Vietnam - Ho Chi Minh	Tel: 39-049-7625286
Tel: 281-894-5983	Tel: 86-29-8833-7252	Tel: 84-28-5448-2100	Netherlands - Drunen
Indianapolis	China - Xiamen		Tel: 31-416-690399
Noblesville, IN	Tel: 86-592-2388138		Fax: 31-416-690340
Tel: 317-773-8323	China - Zhuhai		Norway - Trondheim
Fax: 317-773-5453	Tel: 86-756-3210040		Tel: 47-72884388
Tel: 317-536-2380			Poland - Warsaw
Los Angeles			Tel: 48-22-3325737
Mission Viejo, CA			Romania - Bucharest
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Fax: 949-462-9608			Spain - Madrid
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Raleigh, NC			Fax: 34-91-708-08-91
Tel: 919-844-7510			Sweden - Gothenberg
New York, NY			Tel: 46-31-704-60-40
Tel: 631-435-6000			Sweden - Stockholm
San Jose, CA			Tel: 46-8-5090-4654
Tel: 408-735-9110			UK - Wokingham
Tel: 408-436-4270			Tel: 44-118-921-5800
Canada - Toronto			Fax: 44-118-921-5820
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